

Final datasheet

Soft and ultra-fast recovery 1200 V Emitter controlled 7 diode for both Industrial and Home Appliance applications

Features

- $V_{RRM} = 1200\text{ V}$
- $I_F = 60\text{ A}$
- 1200 V emitter controlled technology
- Maximum junction temperature $T_{vjmax} = 175^\circ\text{C}$
- Low forward voltage (V_F)
- Low reverse recovery charge
- Ultrafast recovery times
- Soft recovery characteristics
- Pb-free lead plating; RoHS compliant
- Humidity robust design

Potential applications

- String inverter
- EV-Charging
- Heat pump

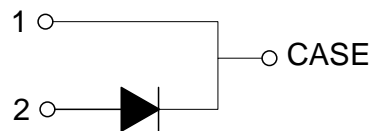
Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Description

Pin definition:

- Pin 1 and backside - Cathode
- Pin 2 - Anode



Type	Package	Marking
IDWD60E120D7	PG-TO247-2-STD-NA8.8	E60MD7

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1 Package

Table 1 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in.) from case	L_E			13		nH
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature	T_{sold}	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Mounting torque	M	M3 screw, Maximum of mounting processes: 3			0.6	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$			0.44	0.57	K/W

2 Diode

Table 2 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} \geq 25 \text{ °C}$		1200	V
Diode forward current, limited by T_{vjmax}	I_F		$T_c = 25 \text{ °C}$	94	A
			$T_c = 100 \text{ °C}$	60	
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpulse}			240	A
Diode surge non repetitive forward current, sine halfwave	I_{FSM}	$t_p = 10 \text{ ms}$	$T_c = 25 \text{ °C}$	228	A
Diode surge repetitive forward current, sine halfwave ¹⁾	I_{FRM}	$t_p = 10 \text{ ms}$	$T_c = 25 \text{ °C}$	180	A
Power dissipation	P_{tot}		$T_c = 25 \text{ °C}$	265	W
			$T_c = 100 \text{ °C}$	132	

1) Not subject to production test. The test was performed with 20k pulses (half-wave rectified sine with 10 ms period).

Table 3 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Diode forward voltage	V_F	$I_F = 60 \text{ A}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		2.5	3	V
			$T_{vj} = 150 \text{ }^\circ\text{C}$		2.35		
			$T_{vj} = 175 \text{ }^\circ\text{C}$		2.3		
Reverse leakage current	I_R	$V_R = 1200 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$			20	μA
			$T_{vj} = 175 \text{ }^\circ\text{C}$		1000		
Diode reverse recovery time	t_{rr}	$V_R = 800 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_F = 60 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		175		ns
			$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_F = 30 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		140		
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_F = 60 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		200		
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_F = 30 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		160		
Diode reverse recovery charge	Q_{rr}	$V_R = 800 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_F = 60 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		1.8		μC
			$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_F = 30 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		1.25		
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_F = 60 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		3.65		
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_F = 30 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		2.65		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode peak reverse recovery current	I_{rrm}	$V_R = 800 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C},$ $I_F = 60 \text{ A},$ $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		22		A
					20		
					34		
					32		
Diode peak rate of fall of reverse recovery current	di_{rr}/dt	$V_R = 800 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C},$ $I_F = 60 \text{ A},$ $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		140		A/ μs
					190		
					190		
					255		
Reverse recovery energy	E_{rec}	$V_R = 800 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C},$ $I_F = 60 \text{ A},$ $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		0.6		mJ
					0.4		
					1.25		
					0.9		
Operating junction temperature	T_{vj}			-40		175	$^\circ\text{C}$

Note: *For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.*

Electrical Characteristic at $T_{vj} = 25^{\circ}\text{C}$, unless otherwise specified.

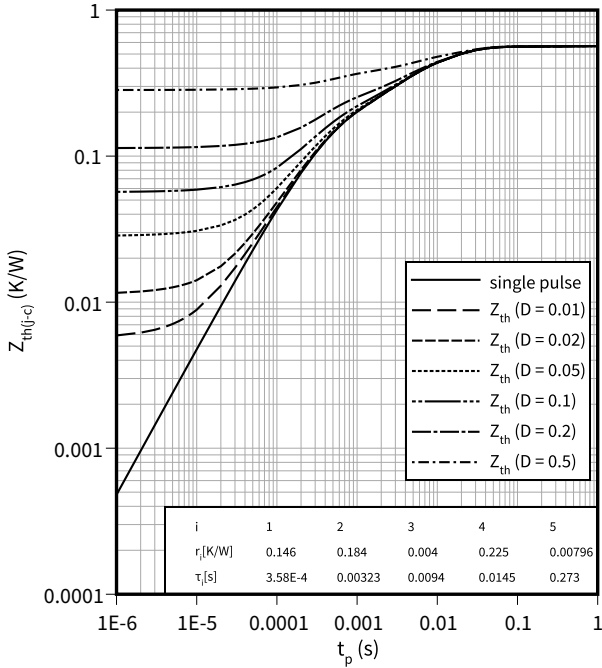
Dynamic test circuit, parasitic inductance $L_{\sigma} = 27 \text{ nH}$, parasitic capacitor $C_{\sigma} = 12 \text{ pF}$ from Fig. E, IKY75N120CH7 was used as IGBT.

3 Characteristics diagrams

Diode transient thermal impedance as a function of pulse width

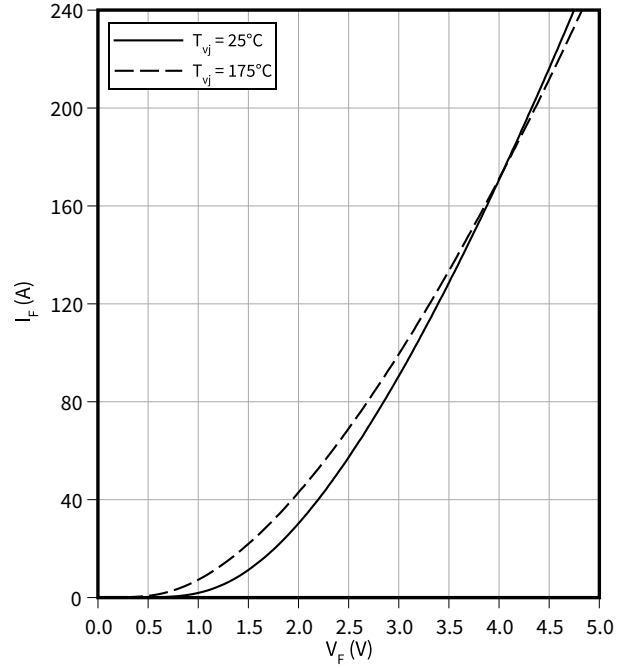
$$Z_{th(j-c)} = f(t_p)$$

$$D = t_p/T$$



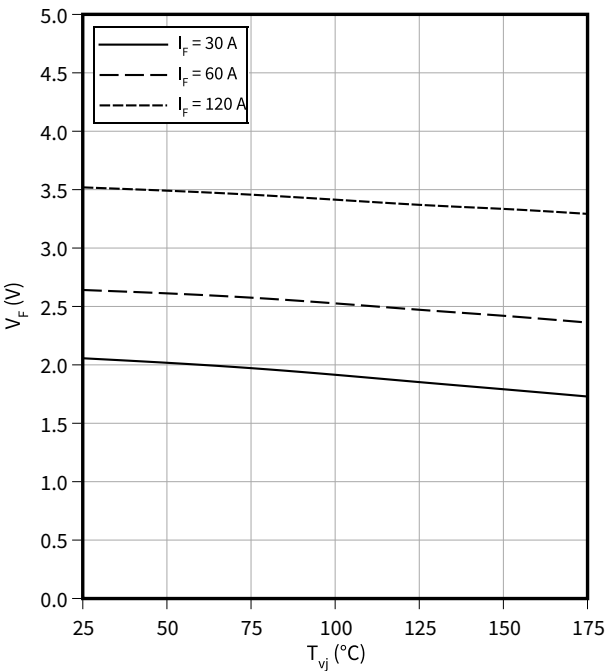
Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$



Typical diode forward voltage as a function of junction temperature

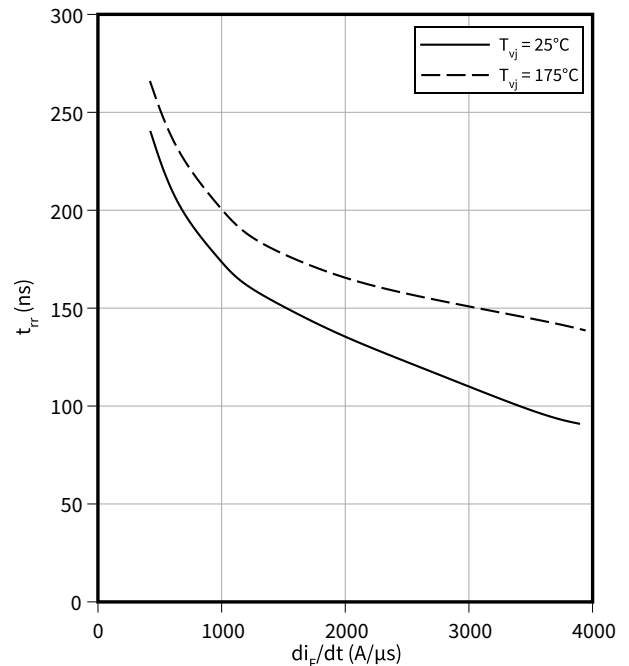
$$V_F = f(T_{vj})$$



Typical reverse recovery time as a function of diode current slope

$$t_{rr} = f(di_F/dt)$$

$V_R = 800 \text{ V}, I_F = 60 \text{ A}$

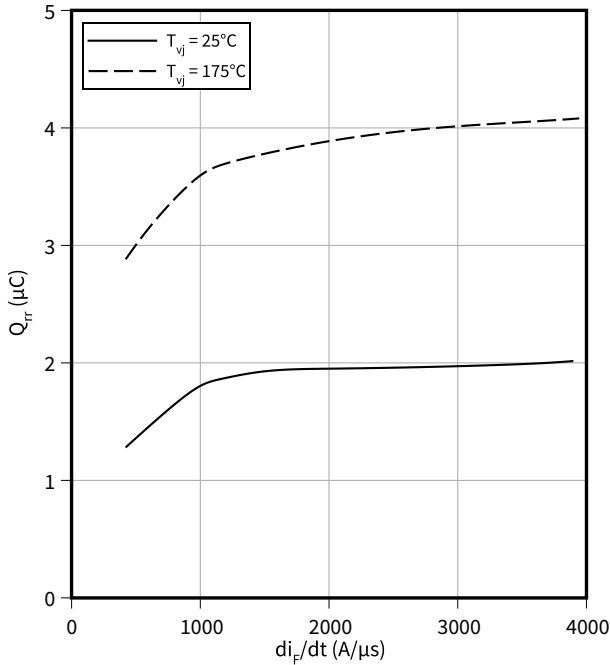


3 Characteristics diagrams

Typical reverse recovery charge as a function of diode current slope

$$Q_{rr} = f(di_F/dt)$$

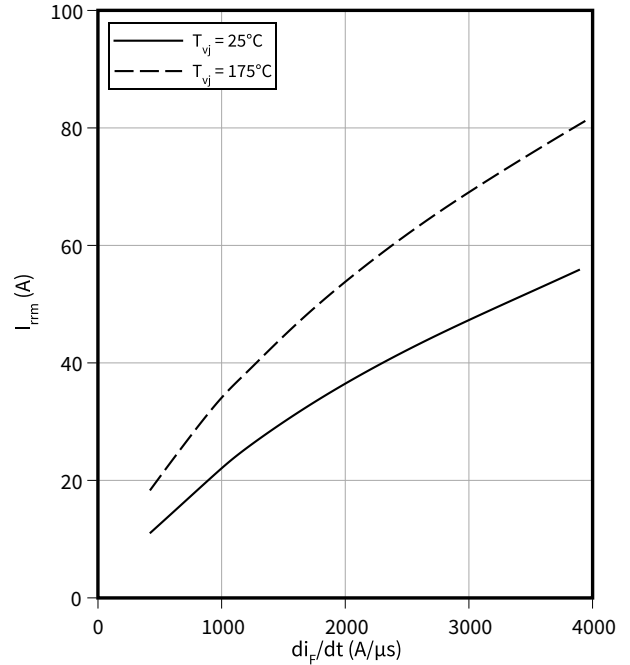
$V_R = 800\text{ V}, I_F = 60\text{ A}$



Typical reverse recovery current as a function of diode current slope

$$I_{rrm} = f(di_F/dt)$$

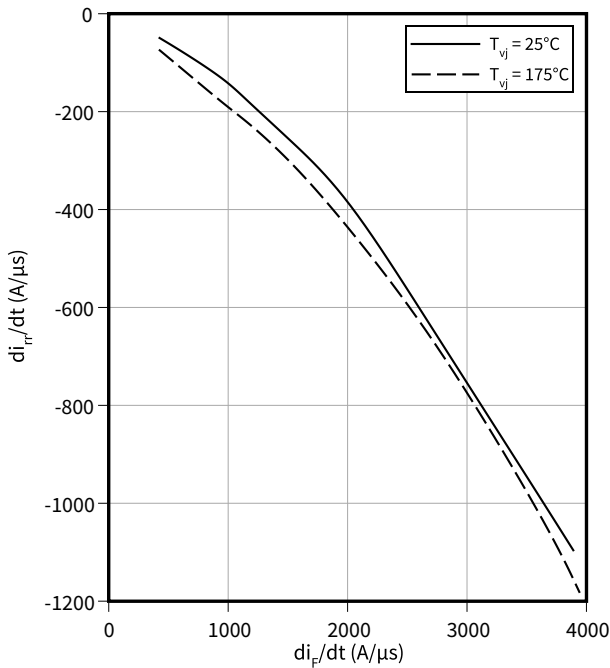
$V_R = 800\text{ V}, I_F = 60\text{ A}$



Typical diode peak rate of fall of reverse recovery current as a function of diode current slope

$$di_{rr}/dt = f(di_F/dt)$$

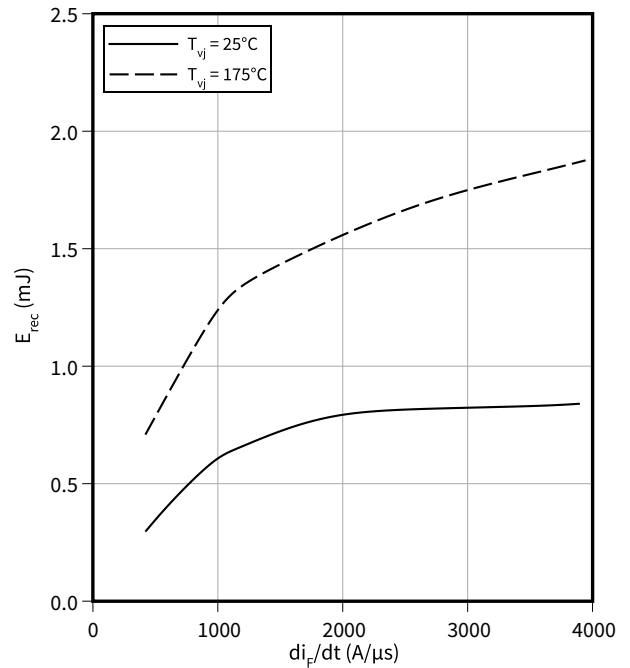
$V_R = 800\text{ V}, I_F = 60\text{ A}$



Typical reverse energy losses as a function of diode current slope

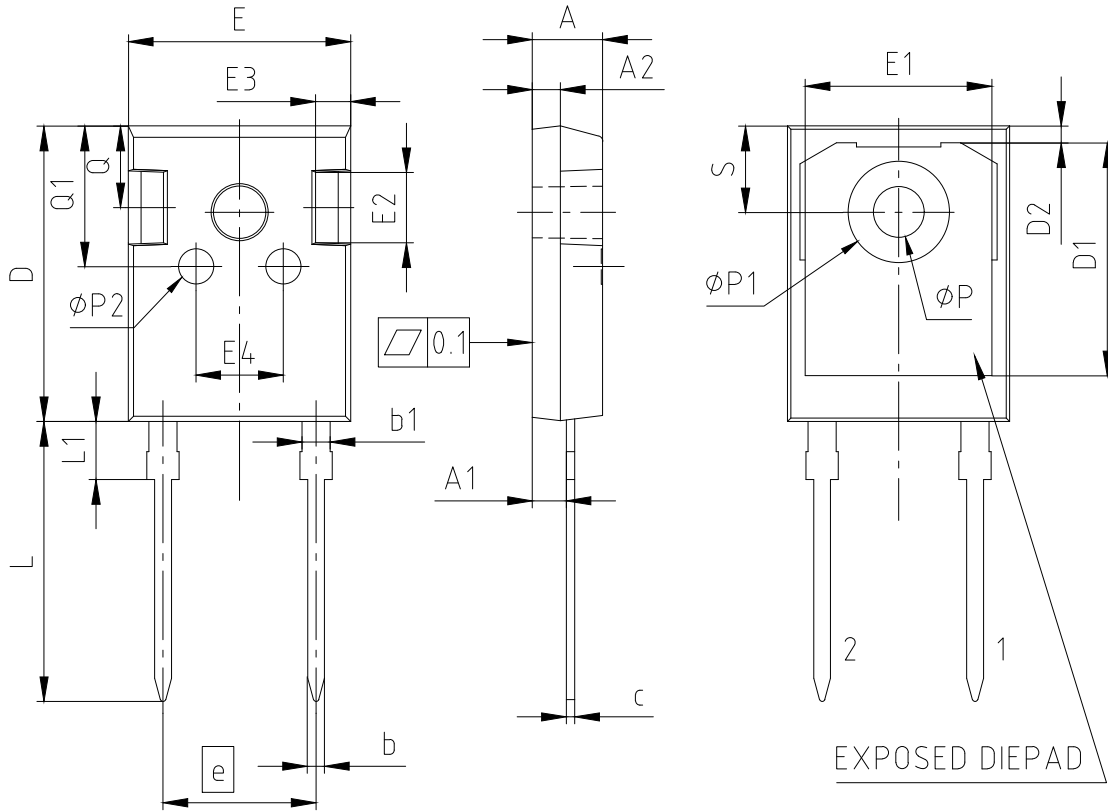
$$E_{rec} = f(di_F/dt)$$

$V_R = 800\text{ V}, I_F = 60\text{ A}$



4 Package outlines

PG-TO247-2-STD-NA8.8



PACKAGE - GROUP NUMBER:		PG-TO247-2-U01			
DIMENSIONS	MILLIMETERS				
	MIN.	MAX.			
A	4.90	5.10	L	19.80	20.10
A1	2.31	2.51	L1	---	4.30
A2	1.90	2.10	øP	3.50	3.70
b	1.16	1.26	øP1	7.00	7.40
b1	1.96	2.06	øP2	2.40	2.60
c	0.59	0.66	Q	5.60	6.00
D	20.90	21.10	Q1	9.80	10.20
D1	16.25	16.85	S	6.05	6.25
D2	1.05	1.35			
E	15.70	15.90			
E1	13.10	13.50			
E2	4.90	5.10			
E3	2.40	2.60			
E4	6.00	6.40			
e	10.88				
N	2				

ALL DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

Figure 1

5 Testing conditions

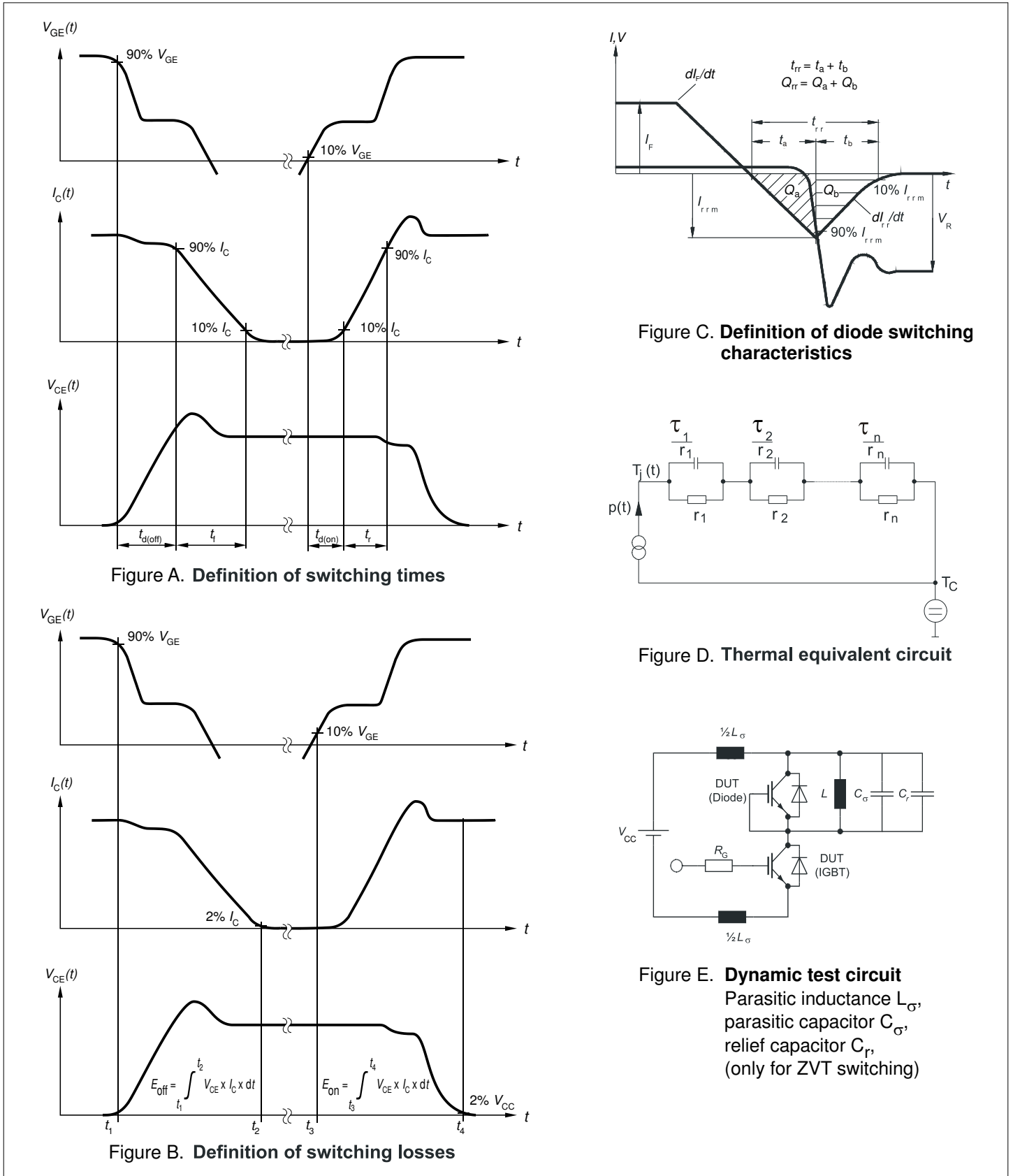


Figure 2

Revision history

Document revision	Date of release	Description of changes
1.00	2023-12-15	Final datasheet

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